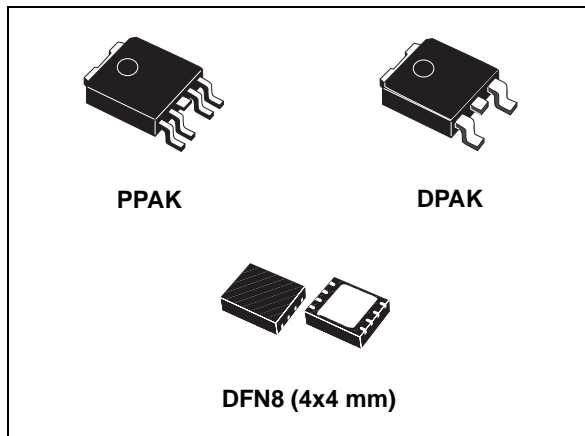


Ultra low drop BiCMOS voltage regulator

Datasheet - production data



- Temperature range: -40 to 125 °C
- Fast dynamic response to line and load changes
- Stable with ceramic capacitor
- Available in PPAK, DPAK and DFN8 (4x4 mm)

Applications

- Microprocessor power supply
- DSP power supply
- Post regulators for switching suppliers
- High efficiency linear regulator

Features

- 0.8 A guaranteed output current
- Ultra low-dropout voltage (150 mV typ. @ 0.8 A load, 20 mV typ. @ 150 mA load)
- Very low quiescent current (1 mA typ. @ 0.8 A load, 1 μ A max. @ 25 °C in off mode)
- Logic-controlled electronic shutdown
- Current and thermal internal limit
- $\pm 1.5\%$ output voltage tolerance @ 25 °C
- Fixed and ADJ output voltages: 1.22 V, 1.8 V, 2.5 V, 3.3 V, ADJ

Description

The LD39080 is a fast, ultra low drop linear regulator which operates from 2.5 V to 6 V input supply.

A wide range of output options is available. The low drop voltage, low noise, and ultra low quiescent current make it suitable for low voltage microprocessors and memory applications. The device is developed on the BiCMOS process which allows the low quiescent current operation regardless of the output load current.

Table 1. Device summary

Part numbers			Output voltage
DPAK (tape and reel)	PPAK (tape and reel)	DFN8 (4x4 mm) ⁽¹⁾	
LD39080DT12-R		LD39080PU12R	1.22 V
LD39080DT18-R	LD39080PT18-R	LD39080PU18R	1.8 V
LD39080DT25-R	LD39080PT25-R	LD39080PU25R	2.5 V
LD39080DT33-R	LD39080PT33-R	LD39080PU33R	3.3 V
	LD39080PT-R	LD39080PU-R	ADJ from 1.22 to 5.0 V

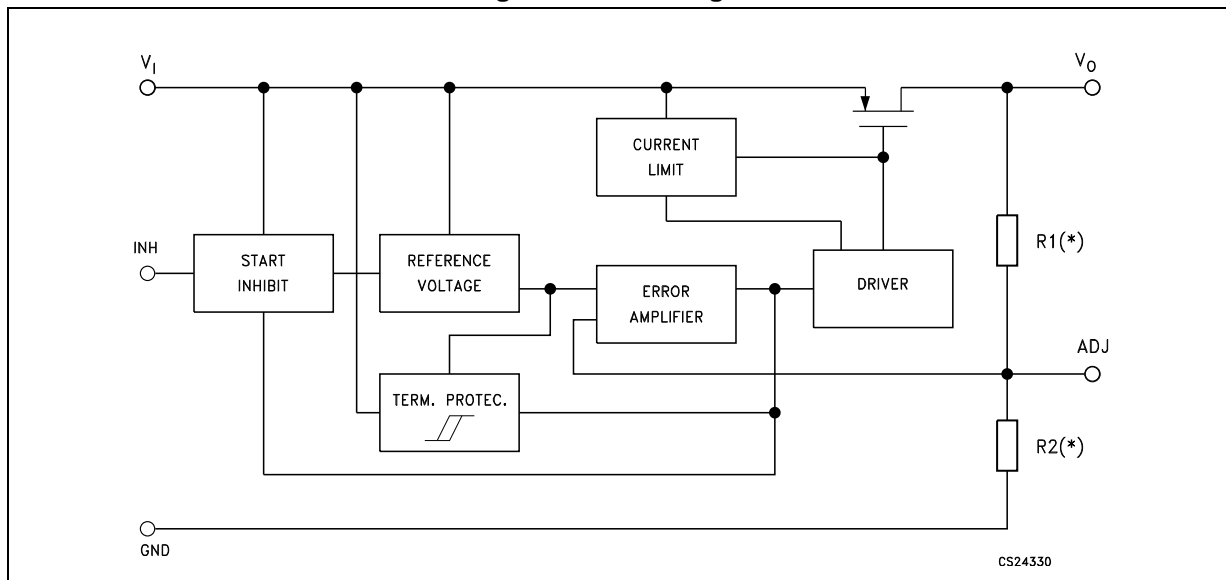
1. Available on request.

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1 Diagram

Figure 1. Block diagram



(*) Not present on ADJ version.

2 Pin configuration

Figure 2. Pin connections (top view for DPAK and PPAK, bottom view for DFN8)

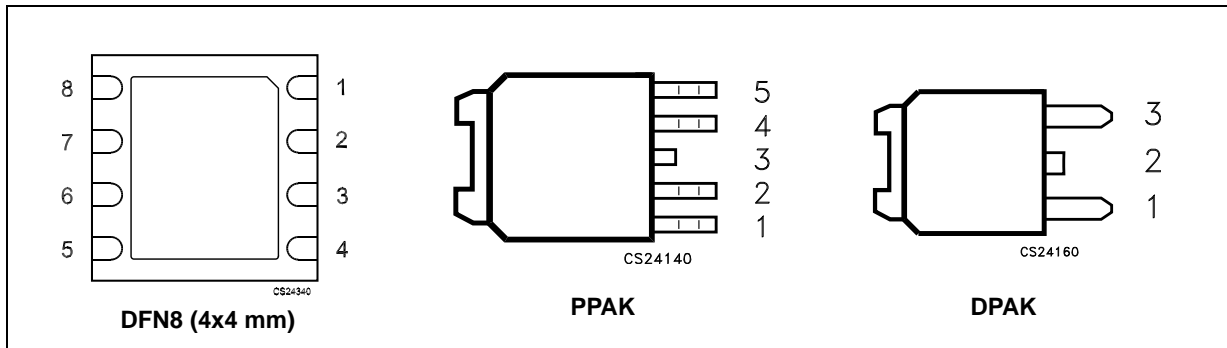


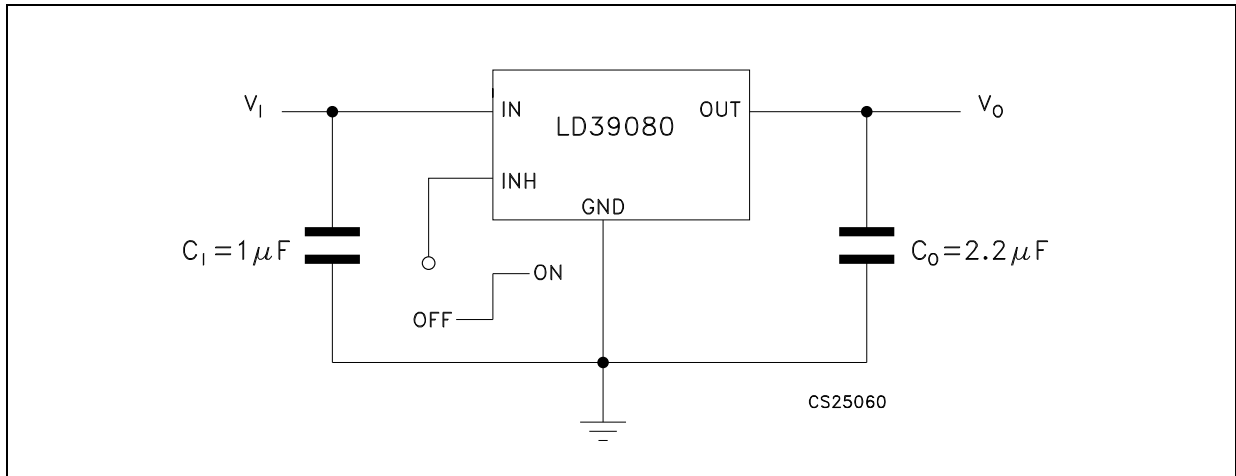
Table 2. Pin description

Pin			Symbol	Note
DFN8 (4x4 mm)	PPAK	DPAK		
8	5		$V_{SENSE}/N.C.$	Fixed version: to be connected to LDO output voltage pins for DFN package and not connected on PPAK
			ADJ	Adjustable version: error amplifier input pin for V_O from 1.22 to 5.0 V
3, 4	2	1	V_I	LDO input voltage: V_I from 2.5 V to 6 V, $C_I=1 \mu F$ not farther than 1 cm from input pin
6, 7	4	3	V_O	LDO output voltage pins, with minimum $C_O = 2.2 \mu F$ needed for stability (refer to C_O vs ESR stability chart)
2	1		V_{INH}	Inhibit input voltage: on mode when $V_{INH} \geq 2 V$, off mode when $V_{INH} \leq 0.3 V$ (do not leave it floating, not internally pulled down/up)
1	3	2	GND	Common ground
5			N.C.	Not connected

3 Typical application circuits

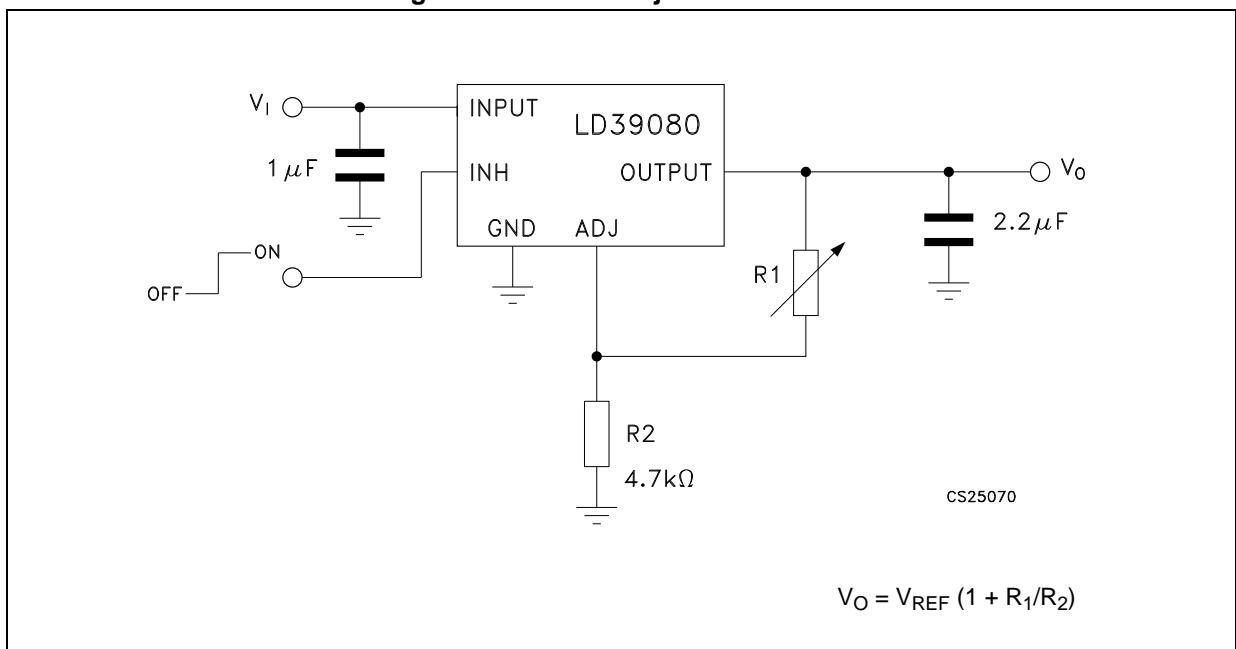
(C_I and C_O capacitors have to be placed as closer as possible to the IC pin)

Figure 3. LD39080 fixed version with inhibit



Note: The inhibit pin is not internally pulled down/up, therefore it must not be left floating. The device has to be disabled when it is connected to GND or to a positive voltage less than 0.3 V.

Figure 4. LD39080 adjustable version



Note: Set R_2 as closer as possible to 4.7 KΩ.

Figure 5. LD39080 DPAK

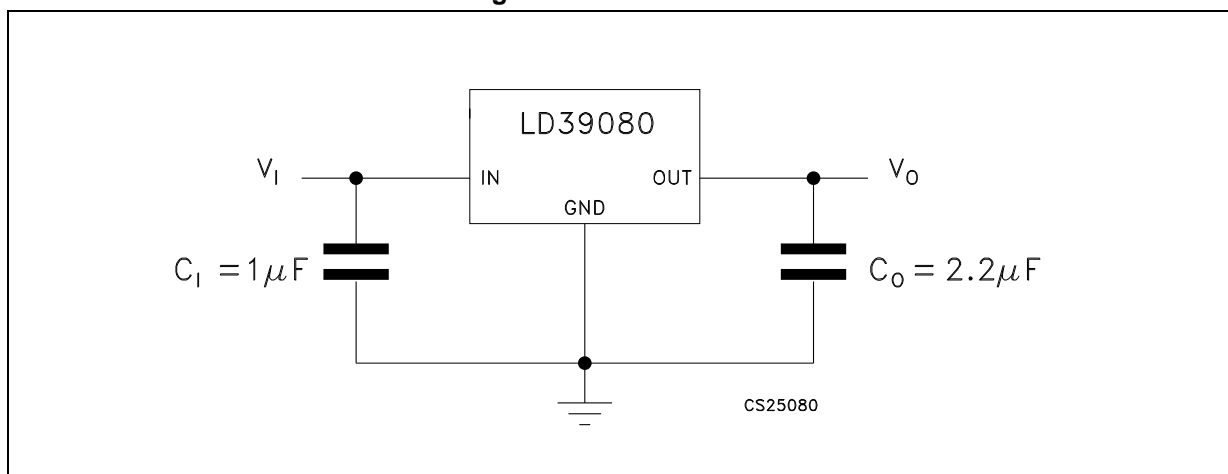
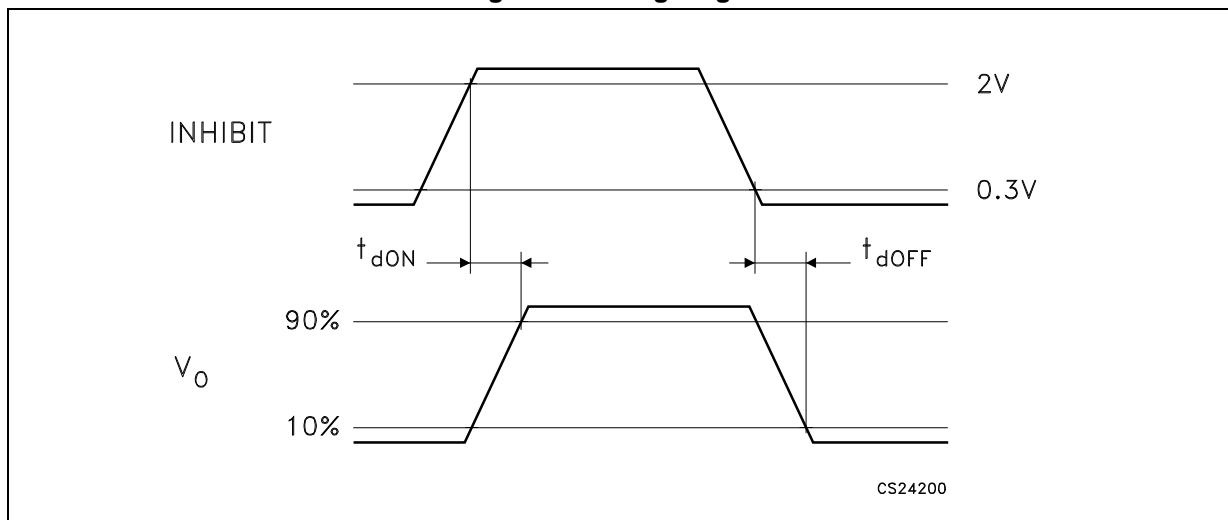


Figure 6. Timing diagram



4 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_I	DC input voltage	-0.3 to 6.5	V
V_{INH}	Inhibit input voltage	-0.3 to $V_I + 0.3$ (6.5 V max.)	V
V_O	DC output voltage	-0.3 to $V_I + 0.3$ (6.5 V max.)	V
V_{ADJ}	ADJ pin voltage	-0.3 to $V_I + 0.3$ (6.5 V max.)	V
I_O	Output current	Internally limited	mA
P_D	Power dissipation	Internally limited	mW
T_{STG}	Storage temperature range	-50 to 150	°C
T_{OP}	Operating junction temperature range	-40 to 125	°C

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. All values are referred to GND.

Table 4. Thermal data

Symbol	Parameter	PPAK	DPAK	DFN8 (4x4 mm) ⁽¹⁾	Unit
R_{thJA}	Thermal resistance junction-ambient	100	100	40	°C/W
R_{thJC}	Thermal resistance junction-case	8	8	10	°C/W

1. With a PCB ground plane and heatsink.

5 Electrical characteristics

$T_J = 25\text{ °C}$, $V_I = V_O + 1\text{ V}$, $C_I = 1\text{ }\mu\text{F}$, $C_O = 2.2\text{ }\mu\text{F}$, $I_{LOAD} = 10\text{ mA}$, $V_{INH} = 2\text{ V}$, unless otherwise specified.

Table 5. Electrical characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_I	Operating input voltage		2.5		6	V
V_O	Output voltage tolerance	$V_I = V_O + 1\text{ V}$, $I_{LOAD} = 10\text{ mA to }0.8\text{ A}$	-1.5		1.5	% of $V_{O(NOM)}$
		$V_I = V_O + 1\text{ V to }6\text{ V}$, $I_{LOAD} = 10\text{ mA to }0.8\text{ A}$ $T_J = -40\text{ to }125\text{ °C}$	-3		3	
V_{REF}	Reference voltage			1.22		V
ΔV_O	Output voltage line regulation	$V_I = V_O + 1\text{ V to }6\text{ V}$		0.04		%
		$V_I = V_O + 1\text{ V to }6\text{ V}$, $T_J = -40\text{ to }125\text{ °C}$		0.1	0.2	%
$\Delta V_O / \Delta I_{LOAD}$	Output voltage load regulation	$I_{LOAD} = 10\text{ mA to }0.8\text{ A}$		0.06		% / A
		$I_{LOAD} = 10\text{ mA to }0.8\text{ A}$, $T_J = -40\text{ to }125\text{ °C}$		0.2	0.4	
V_{DROP}	Dropout voltage ($V_I - V_O$)	$I_{LOAD} = 150\text{ mA}$, $T_J = -40\text{ to }125\text{ °C}$		20	40	mV
		$I_{LOAD} = 0.8\text{ A}$, $T_J = -40\text{ to }125\text{ °C}$		150	300	
I_Q	Quiescent current: on mode	$I_{LOAD} = 10\text{ mA to }0.8\text{ A}$, $V_{INH} = 2\text{ V}$ $T_J = -40\text{ to }125\text{ °C}$		1	2.5	mA
	Quiescent current: off mode	$V_{INH} = 0.3\text{ V}$			1	μA
		$V_{INH} = 0.3\text{ V}$, $T_J = -40\text{ to }125\text{ °C}$			5	
Short-circuit protection						
I_{SC}	Short-circuit protection	$R_L = 0$		1.6		A
Inhibit Input						
V_{INH}	Inhibit threshold low	$V_I = 2.5\text{ to }6\text{ V off}$ $T_J = -40\text{ to }125\text{ °C}$			0.3	V
	Inhibit threshold high		2			

Table 5. Electrical characteristics (continued)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
T_{D-OFF}	Current limit	$I_{LOAD} = 0.8 \text{ A}$, $V_O = 3.3 \text{ V}$		15		μs
T_{D-ON}	Current limit	$I_{LOAD} = 0.8 \text{ A}$, $V_O = 3.3 \text{ V}$		15		
I_{INH}	Inhibit input current ⁽¹⁾	$V_I = 6 \text{ V}$, $V_{INH} = 0 \text{ to } 6 \text{ V}$		± 0.1	± 1	μA
AC parameters						
SVR	Supply voltage rejection	$V_I = 4.5 \pm 1 \text{ V}$, $V_O = 3.3 \text{ V}$, $I_{LOAD} = 10 \text{ mA}$,	$f = 120 \text{ Hz}$		65	dB
			$f = 1 \text{ kHz}$		55	
e_N	Output noise voltage	$B_W = 10 \text{ Hz to } 100 \text{ kHz}$, $C_O = 2.2 \mu\text{F}$, $V_O = 2.5 \text{ V}$		100		μV_{RMS}
T_{SHDN}	Thermal shutdown off			170		$^{\circ}\text{C}$
	Hysteresis			10		

1. Guaranteed by design.

6 Typical performance characteristics

$T_J = 25\text{ }^\circ\text{C}$, $V_I = V_O + 1\text{ V}$, $C_I = 1\text{ }\mu\text{F}$, $C_O = 2.2\text{ }\mu\text{F}$, $I_{LOAD} = 10\text{ mA}$, $V_{INH} = V_I$, unless otherwise specified.

Figure 7. Output voltage vs temperature

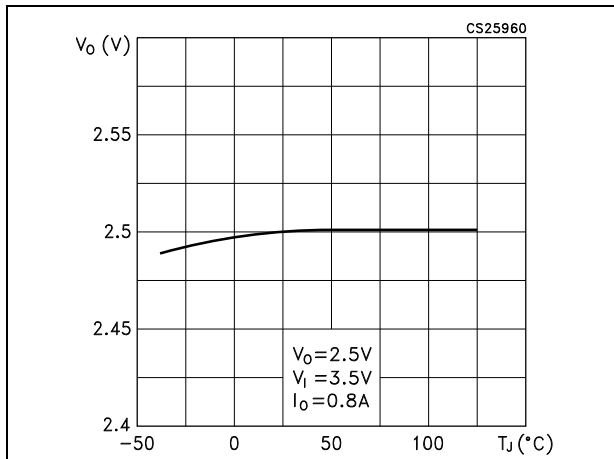


Figure 8. Dropout voltage vs temperature

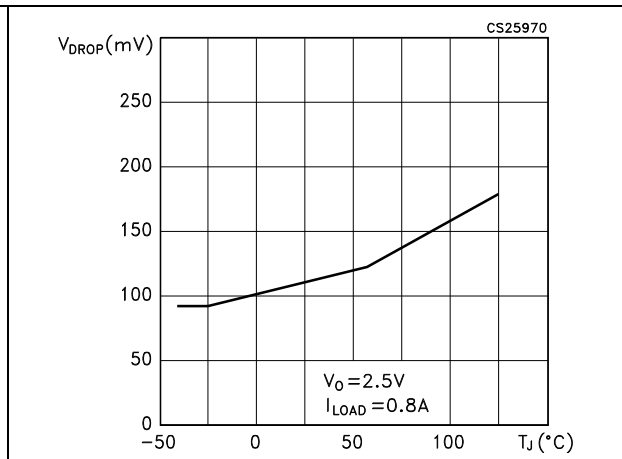


Figure 9. Dropout voltage vs output current

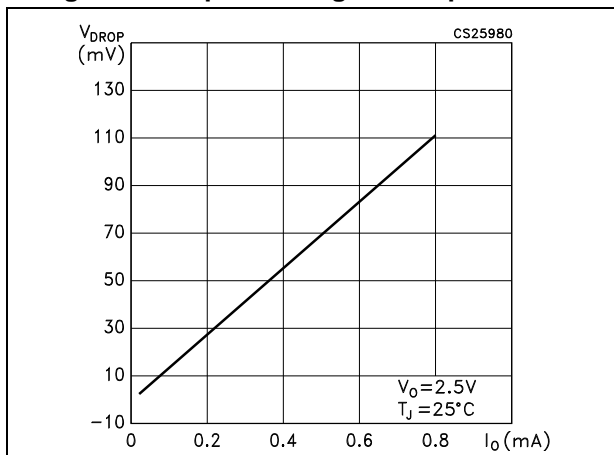


Figure 10. Quiescent current vs output current

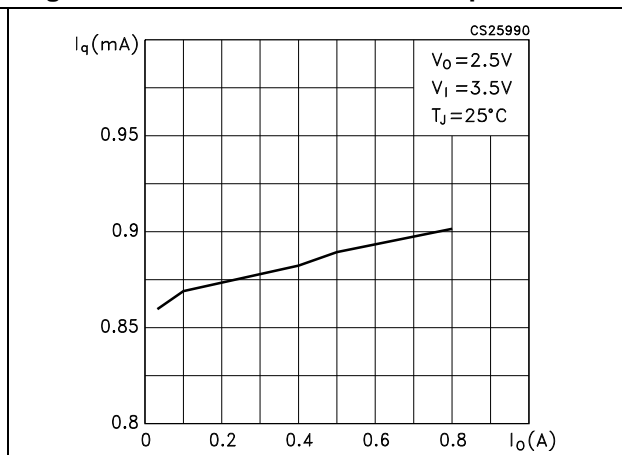


Figure 11. Quiescent current vs supply voltage

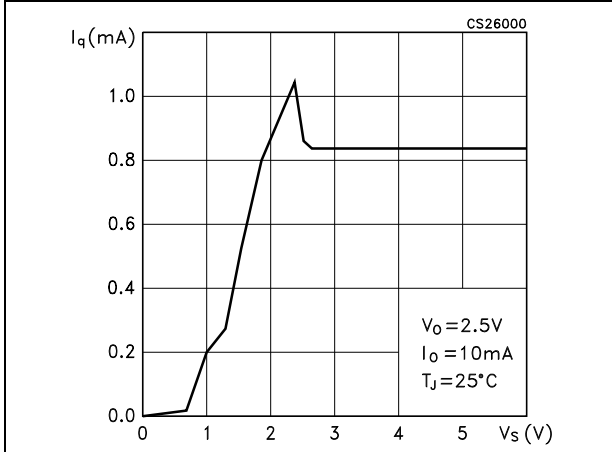


Figure 12. Off-state current vs temperature

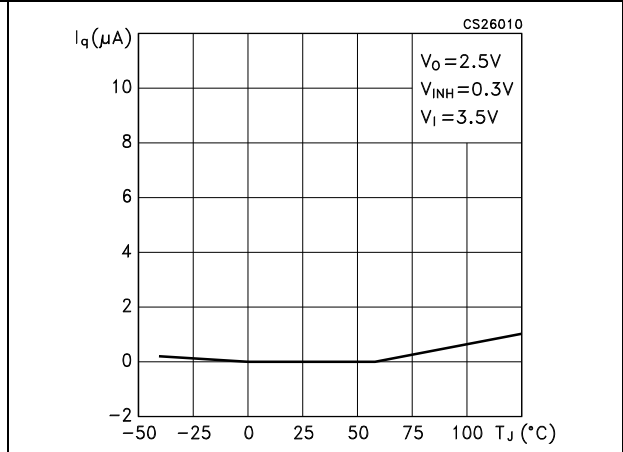


Figure 13. Quiescent current vs temperature

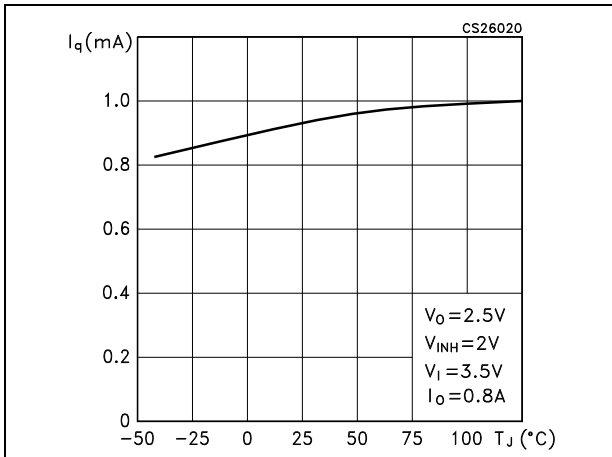


Figure 14. Short-circuit current vs temperature

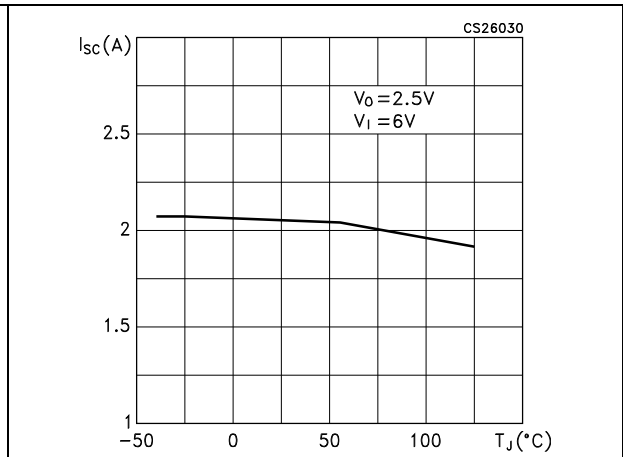


Figure 15. Output voltage vs input voltage

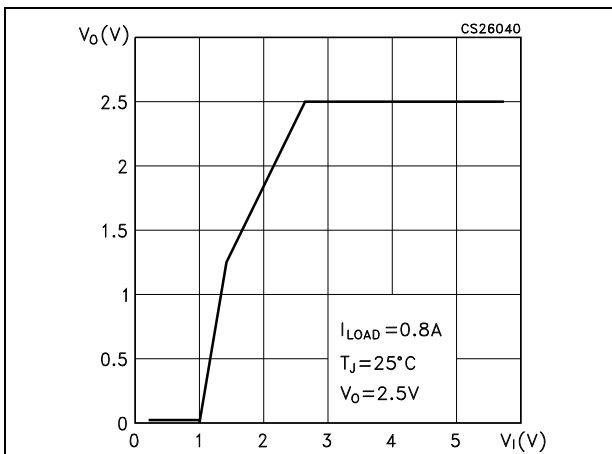


Figure 16. Supply voltage rejection vs temperature

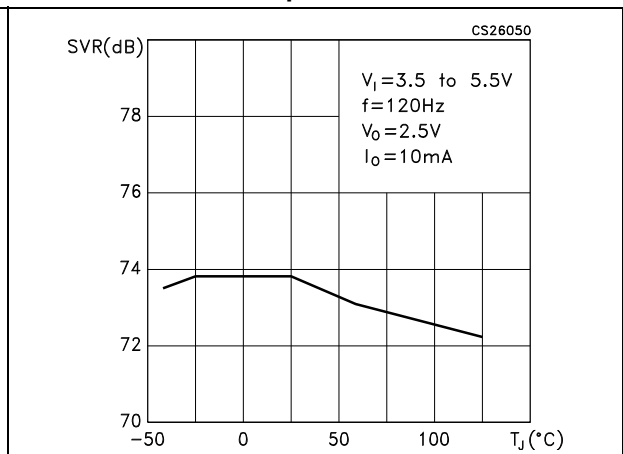


Figure 17. Stability region vs C_O and ESR (at 100 kHz)

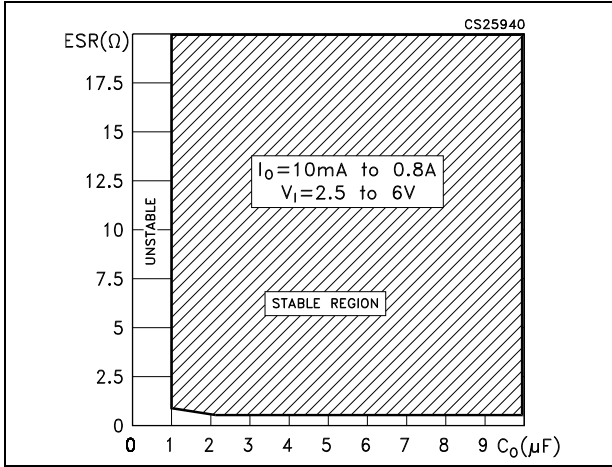


Figure 18. Stability region vs C_O and low ESR (at 100 kHz)

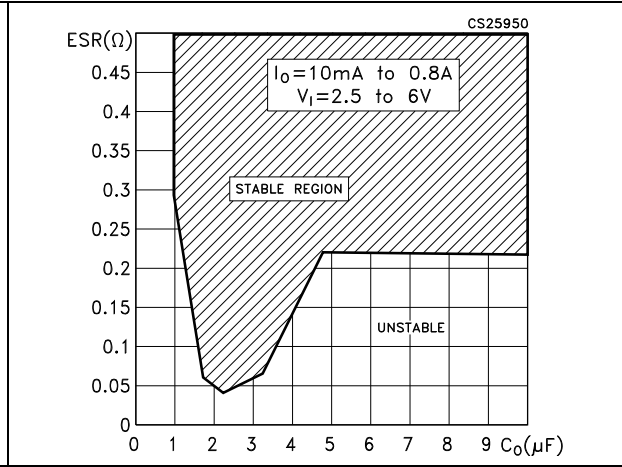


Figure 19. Load transient

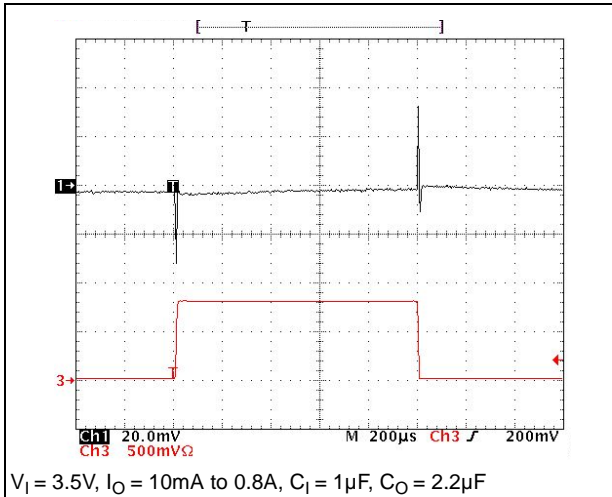
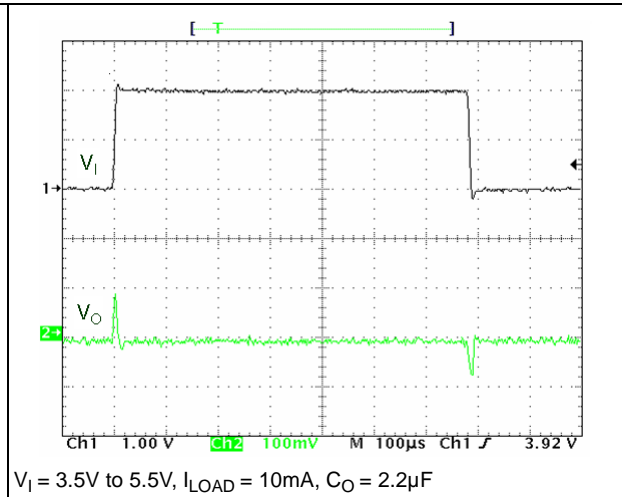


Figure 20. Line transient



7 Application notes

7.1 External capacitor

The LD39080 requires external capacitors to assure the stability. These capacitors have to meet the requirements of minimum capacitance and equivalent series resistance (see [Figure 17](#) [Figure 18](#)). The input/output capacitors cannot be farther than 1 cm from the relative pins and have to be connected directly to the input/output ground pins using traces without any current flowing through them. Ceramic or electrolytic capacitors can be used.

7.2 Input capacitor

An input capacitor, whose minimum value is 1 μF , is required (the amount of capacitance can be increased without any limit). This capacitor cannot be farther than 1 cm from the input pin of the device and has to return to clean analog ground. Ceramic, tantalum or film capacitors can be used.

7.3 Output capacitor

Ceramic or tantalum capacitors can be used but the output capacitor has to meet the requirements of minimum capacitance and ESR (equivalent series resistance) value. A minimum capacitance of 2.2 μF is a good choice to guarantee the stability of the regulator. Anyway, other C_O values can be used as per [Figure 17](#) [Figure 18](#), where the allowable ESR range is seen as a function of the output capacitance. The curve represents the stability region over the full temperature and I_O range.

7.4 Thermal note

The output capacitor has to maintain its ESR in the stable region over the operating temperature range to assure the stability. Besides, capacitor tolerance and temperature variation have to be taken into account to assure the minimum amount of capacitance all time.

7.5 Inhibit input operation

The inhibit pin can be used to turn off the regulator when pulled down, therefore by reducing the current consumption below 1 μA . When the inhibit feature is not used, this pin has to be tied to V_I to turn on the regulator output all the time. To assure the right operation, the signal source, used to drive the inhibit pin, has to swing above and below the specified thresholds listed in [Section 5: Electrical characteristics](#) (V_{IH} V_{IL}). The inhibit pin must not be left floating because it is not internally pulled down/up.

8 Package mechanical data

Figure 21. PPAK drawings

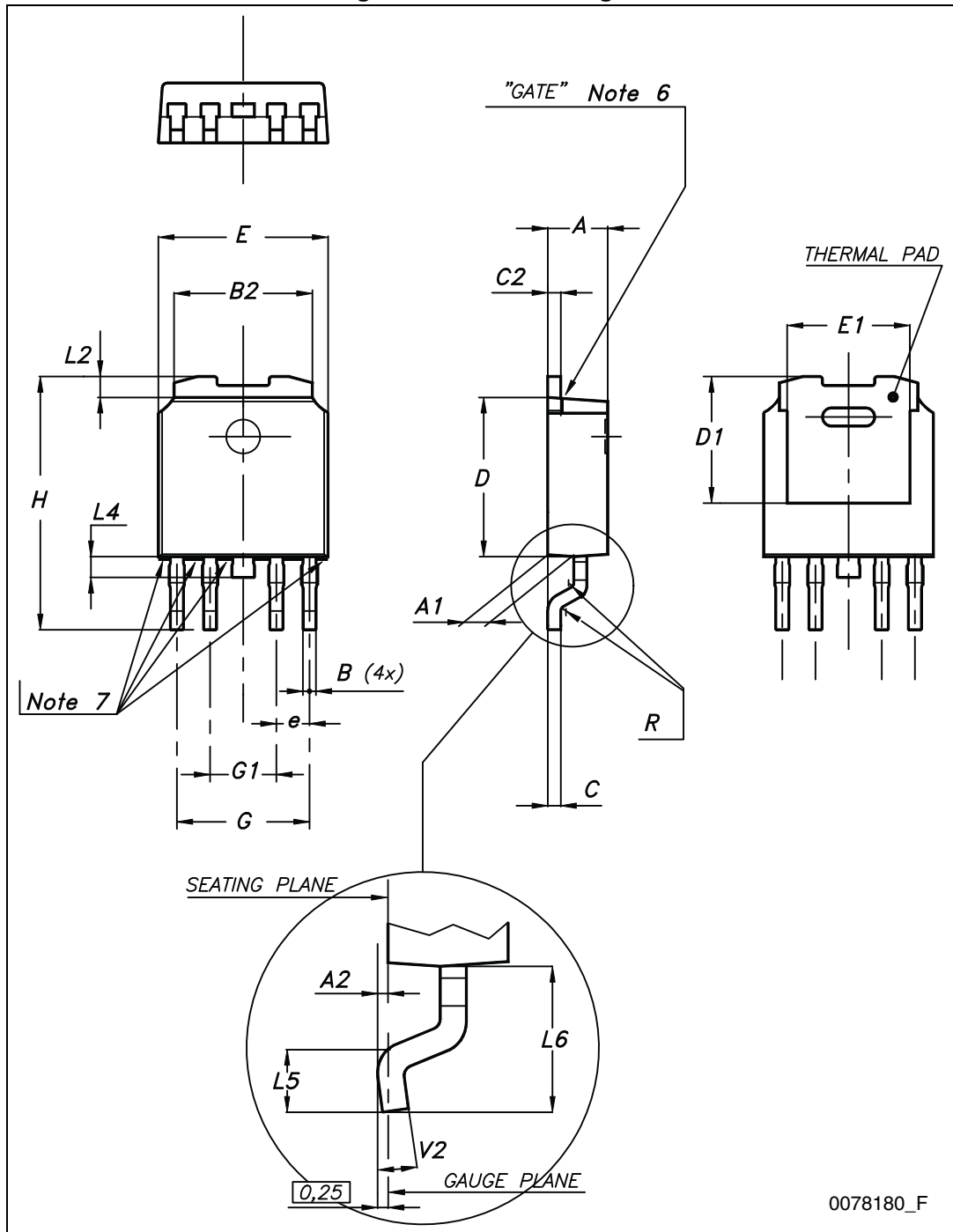


Table 6. PPAK mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	2.2		2.4
A1	0.9		1.1
A2	0.03		0.23
B	0.4		0.6
B2	5.2		5.4
C	0.45		0.6
C2	0.48		0.6
D	6		6.2
D1		5.1	
E	6.4		6.6
E1		4.7	
e		1.27	
G	4.9		5.25
G1	2.38		2.7
H	9.35		10.1
L2		0.8	1
L4	0.6		1
L5	1		
L6		2.8	
R		0.20	
V2	0°		8°

Figure 22. DPAK drawings

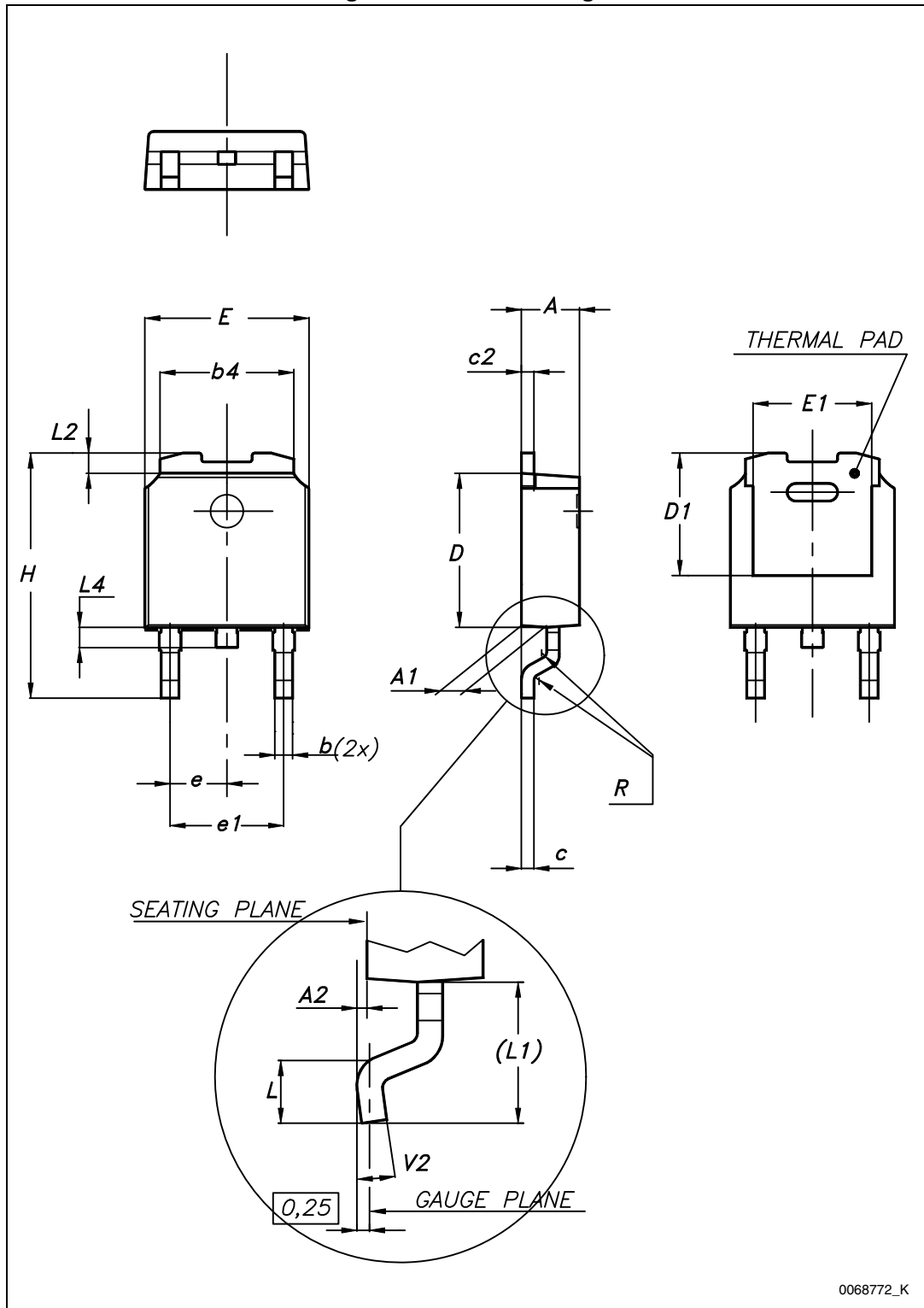
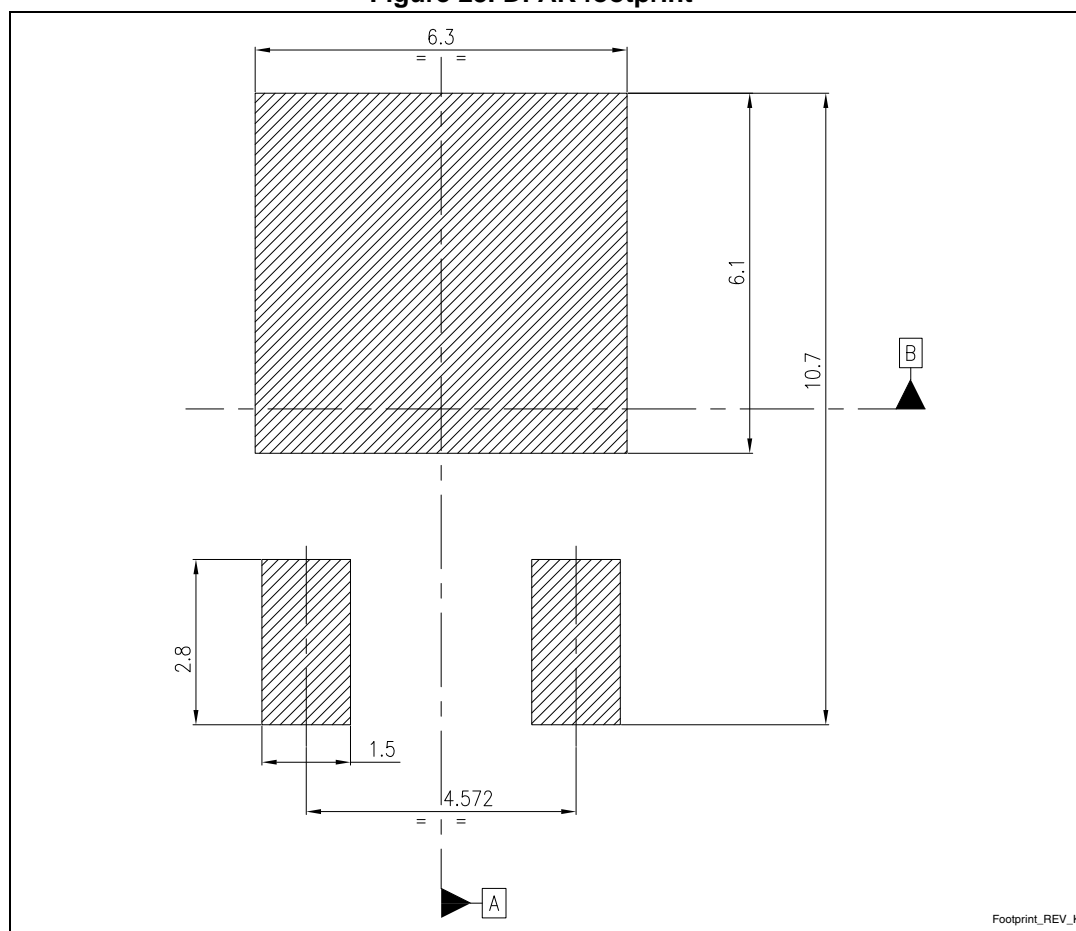


Table 7. DPAK mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
e		2.28	
e1	4.40		4.60
H	9.35		10.10
L	1.00		1.50
(L1)		2.80	
L2		0.80	
L4	0.60		1.00
R		0.20	
V2	0°		8°

Figure 23. DPAK footprint (a)



a. All dimensions are in millimeters.

Figure 24. DFN8 (4x4 mm) drawings

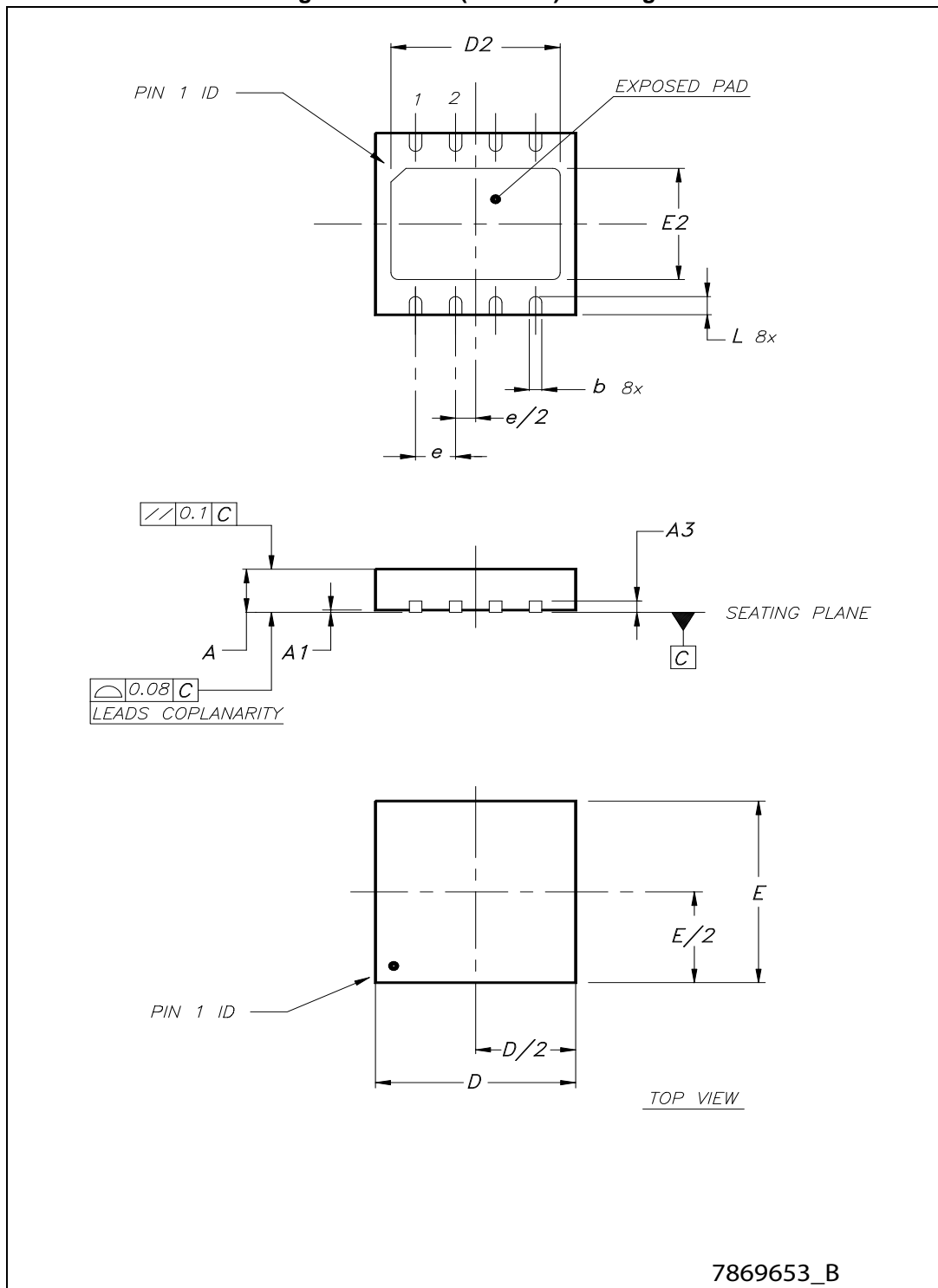
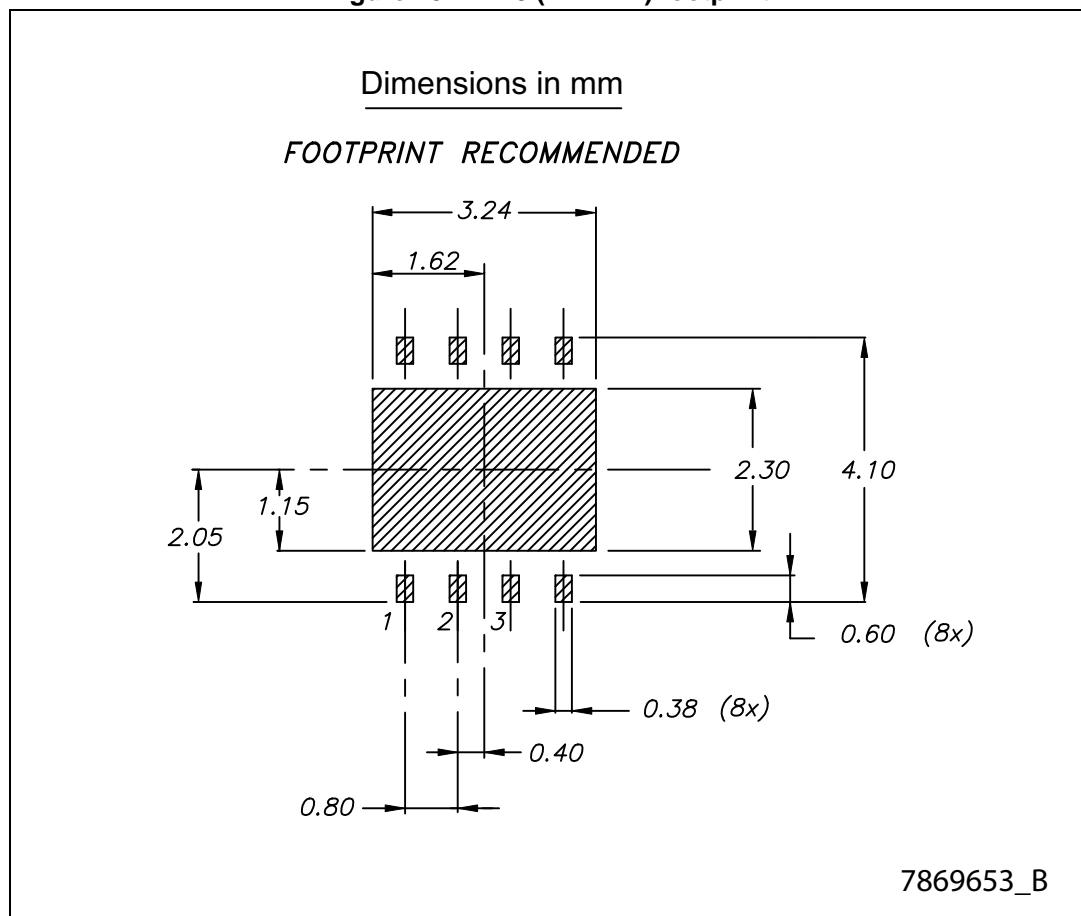


Table 8. DFN8 (4x4 mm) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80	0.90	1
A1	0	0.02	0.05
A3		0.20	
b	0.23	0.30	0.38
D	3.90	4	4.10
D2	2.82	3	3.23
E	3.90	4	4.10
E2	2.05	2.20	2.30
e		0.80	
L	0.40	0.50	0.60

Figure 25. DFN8 (4x4 mm) footprint



9 Packaging mechanical data

Figure 26. Tape for PPAK and DPAK

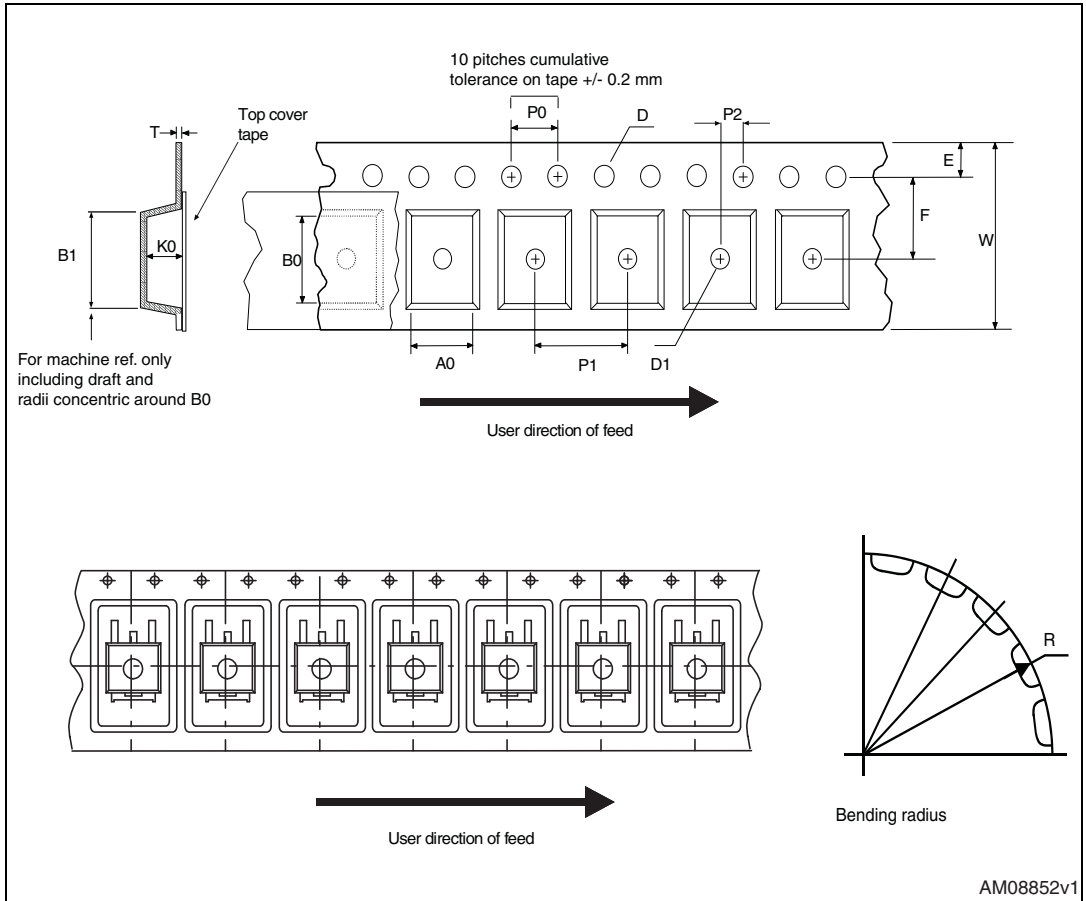


Figure 27. Reel for PPAK and DPAK

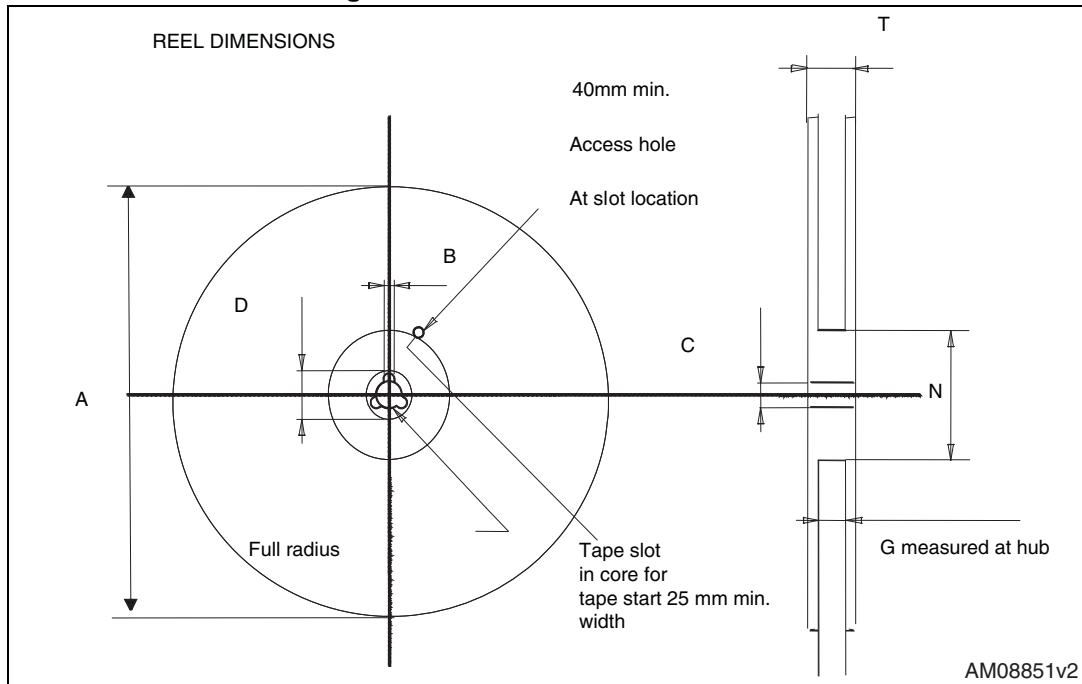


Table 9. PPAK and DPAK tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	B	1.5	
B1		12.1	C	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	T		22.4
K0	2.55	2.75			
P0	3.9	4.1		Base qty.	2500
P1	7.9	8.1		Bulk qty.	2500
P2	1.9	2.1			
R	40				
T	0.25	0.35			
W	15.7	16.3			

Figure 28. DFN8 (4x4 mm) tape and reel mechanical data

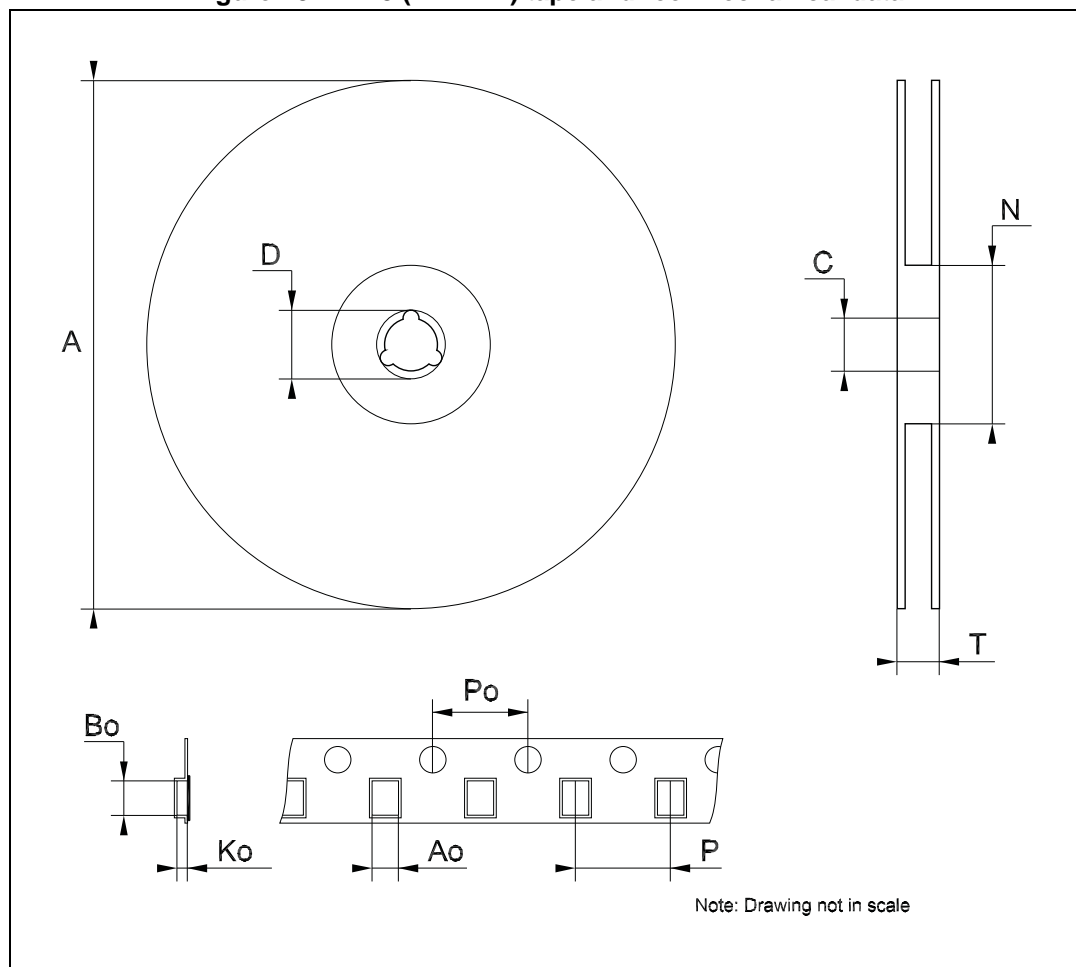


Table 10. DFN8 (4x4 mm) tape and reel dimensions

Dim.	mm		
	Min.	Typ.	Max.
A			330
C	12.8		13.2
D	20.2		
N	99		101
T			14.4
Ao		4.35	
Bo		4.35	
Ko		1.1	
Po		4	
P		8	

10 Revision history

Table 11. Document revision history

Date	Revision	Changes
26-Jan-2007	1	Initial release.
25-Mar-2014	2	Updated features in cover page, <i>Section 5: Electrical characteristics</i> , <i>Section 6: Typical performance characteristics</i> , <i>Section 7: Application notes</i> , <i>Section 8: Package mechanical data</i> . Added <i>Section 9: Packaging mechanical data</i> . Minor text changes.

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